Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product Information in this Catalog

Product information in this catalog is as of January 2021. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

Limited Application

1. Equipment Intended for Use

The products listed in this catalog are intended for generalpurpose and standard use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets.

TAIYO YUDEN has the line-up of the products intended for use in automotive electronic equipment, telecommunications infrastructure and industrial equipment, or medical devices classified as GHTF Classes A to C (Japan Classes I to III). Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, dataprocessing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment *1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices *2

- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, underwater work equipment, etc.)
- (6) Military equipment
- Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above

- 1. There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
- 2. Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such

■ TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

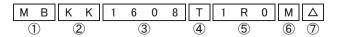
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METAL WIRE-WOUND CHIP POWER INDUCTORS (MCOIL™ MB SERIES)

REFLOW

■PARTS NUMBER

* Operating Temp.: -40~+105°C (Including self-generated heat)



△=Blank	space
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①Series name

Code	Series name
MB	Metal Wire-Wound chip power inductor

②Dimensions(T)

E Billionologio (17	·
Code	Dimensions (T) [mm]
KK	1.0
MK	1.2
	Code KK

③Dimensions(L×W)

Code	Type (inch)	Dimensions (L×W)[mm]	
1608	1608 (0603)	1.6 × 0.8	
2012	2012 (0805)	2.0 × 1.25	
2520	2520(1008)	2.5 × 2.0	

4 Packaging

Code	Packaging
Т	Taping

5 Nominal inductance

©						
Code (example)	Nominal inductance[μ H]					
R24	0.24					
1R0	1.0					
4R7	4.7					

⑥Inductance tolerance

Code	Inductance tolerance
М	±20%
N	±30%

7Internal code

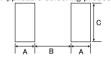
■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY

Recommended Land Patterns

Surface Mounting

•Mounting and soldering conditions should be checked beforehand.

· Applicable soldering process to these products is reflow soldering only.



Туре	Α	В	С
1608	0.55	0.70	1.00
2012	0.60	1.00	1.45
2520	0.60	1.50	2.00

Unit:mm

Type	1	w	т		Standard quantity[pcs]		
Туре	_	VV	'	е	Paper tape	Embossed tape	
MBKK1608	1.6±0.2	0.8±0.2	1.0 max	0.45±0.15		3000	
MBKK1008	(0.063 ± 0.008)	(0.031 ± 0.008)	(0.040 max)	(0.016 ± 0.006)	_		
MBKK2012	2.0±0.2	1.25±0.2	1.0 max	0.5±0.2		2000	
MIDNIZUTZ	(0.079 ± 0.008)	(0.049 ± 0.008)	(0.040 max)	(0.020 ± 0.008)	_	3000	
MBMK2520	2.5±0.2	2.0±0.2	1.2 max	0.5±0.2		3000	
INDINIK 2020	(0.098 ± 0.008)	(0.079 ± 0.008)	(0.047 max)	(0.020 ± 0.008)	_		
						Unit:mm(inch)	

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for General Electronic Equipment

PARTS NUMBER

	MBKK1608(0603)) type	[Thickness: 1.0mm	Thickness:1.0mm max.]					
			Nominal inductance		Self-resonant	DC Resistance	Rated current	※) [mA] (max.)	Measuring
Parts number	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)	$[\Omega]$ (max.)	Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]	
	MBKK1608TR24N	RoHS	0.24	±30%	-	0.049	1,650	2,300	1.0
	MBKK1608TR47N	RoHS	0.47	±30%	-	0.104	1,100	1,400	1.0
	MBKK1608TR68N	RoHS	0.68	±30%	-	0.120	950	1,200	1.0
	MBKK1608T1R0M	RoHS	1.0	±20%	-	0.150	800	1,150	1.0
	MBKK1608T1R5M	RoHS	1.5	±20%	-	0.200	650	1,000	1.0
	MBKK1608T2R2M	RoHS	2.2	±20%	-	0.345	520	750	1.0
	MBKK1608T3R3M	RoHS	3.3	±20%	-	0.512	450	600	1.0
	MDVV1600TAD7M	D-HC	4.7	± 2004	_	0.720	270	EOO	1.0

	MBRAZOTZ (0000) typo Trinolation Tristinia max.							
		Nominal inductance	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (max.)	Rated current ※) [mA](max.)		Measuring
Parts number	EHS	[μ H]				Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
MBKK2012TR24N	RoHS	0.24	±30%	-	0.041	3,000	2,400	1.0
MBKK2012TR47N	RoHS	0.47	±30%	-	0.078	2,000	1,650	1.0
MBKK2012TR68N	RoHS	0.68	±30%	-	0.090	1,800	1,500	1.0
MBKK2012T1R0M	RoHS	1.0	±20%	-	0.106	1,500	1,450	1.0
MBKK2012T1R5M	RoHS	1.5	±20%	-	0.173	1,200	1,100	1.0
MBKK2012T2R2M	RoHS	2.2	±20%	-	0.290	900	850	1.0
MBKK2012T3R3M	RoHS	3.3	±20%	-	0.500	700	650	1.0
MBKK2012T4R7M	RoHS	4.7	±20%	-	0.615	600	600	1.0

Inibilitzozo (1000) type Trillokiless. 1.2min max.								
	Parts number EHS	Nominal inductance	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (max.)	Rated current ※) [mA](max.)		Measuring
Parts number		[μ H]				Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
MONICOFOOTDOAN	D 110	0.04	1.000/		0.000			4.0
MBMK2520TR24N	RoHS	0.24	±30%	_	0.026	4,750	3,500	1.0
MBMK2520TR47N	RoHS	0.47	±30%	-	0.042	3,900	2,600	1.0
MBMK2520TR68N	RoHS	0.68	±30%	-	0.058	3,150	2,150	1.0
MBMK2520T1R0M	RoHS	1.0	±20%	-	0.072	2,350	1,850	1.0
MBMK2520T1R5M	RoHS	1.5	±20%	-	0.106	2,050	1,500	1.0
MBMK2520T2R2M	RoHS	2.2	±20%	-	0.159	1,800	1,250	1.0
MBMK2520T3R3M	RoHS	3.3	±20%	-	0.260	1,400	970	1.0
MBMK2520T4R7M	RoHS	4.7	±20%	-	0.380	1,150	800	1.0

^{*}X) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

^{*}X) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C. (at 20°C)

^{*)} The rated current value is following either Idc1 or Idc2, which is the lower one.

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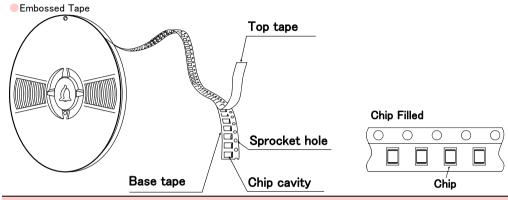
METAL WIRE-WOUND CHIP POWER INDUCTORS (MCOILTM MB SERIES/MCOILTM MB-H SERIES)

■PACKAGING

1 Minimum Quantity

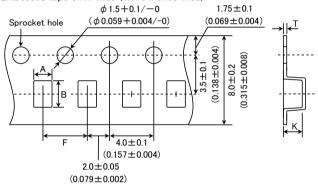
Time	Standard Quantity [pcs]
Туре	Tape & Reel
MBKK1608/MBKK1608H	3000
MBKK2012	3000
MBMK2520/MBMK2520H	3000

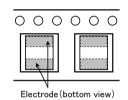
2Tape Material



3Taping dimensions

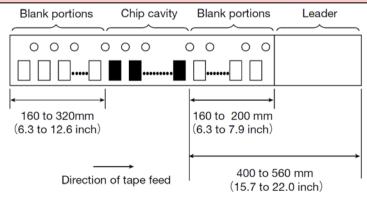
Embossed tape 8mm wide (0.315 inches wide)



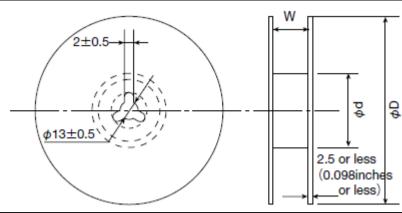


Type	Chip	cavity	Insertion pitch	Tape thickness		
туре	Α	В	F	T	K	
MBKK1608 / MBKK1608H	1.1	1.9	4.0±0.1	0.25 ± 0.05	1.2 max	
MBKK1008/ MBKK1008H	(0.043)	(0.075)	(0.157 ± 0.004)	(0.010 ± 0.002)	(0.047 max)	
MBKK2012	1.45	2.2	4.0±0.1	0.25 ± 0.05	1.2 max	
	(0.057)	(0.087)	(0.157 ± 0.004)	(0.010 ± 0.002)	(0.047 max)	
MDMIZOEGO ZMDMIZOEGOU	2.3	2.8	4.0±0.1	0.3±0.05	1.45 max	
MBMK2520/MBMK2520H	(0.091)	(0.110)	(0.157 ± 0.004)	(0.012 ± 0.002)	(0.057 max)	
					Unit:mm(inch)	

4 Leader and Blank portion



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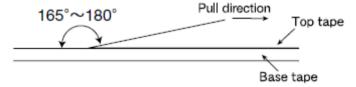


Time	Reel size (Reference values)			
Туре	ΦD	ϕ d	W	
MBKK1608/MBKK1608H	180+0/-3	60+1/-0	100+15	
MBKK2012	(7.087+0/-0.118)	(2.36+0.039/0)	10.0±1.5 (0.394±0.059)	
MBMK2520/MBMK2520H	(7.067+0/-0.116)	(2.30+0.039/0)	(0.394±0.059)	

Unit:mm(inch)

®Top Tape Strength

The top The top tape requires a peel-off force of 0.2 to 0.7N in the direction of the arrow as illustrated below.



METAL WIRE-WOUND CHIP POWER INDUCTORS (MCOIL™ MB SERIES ∕ MCOIL™ MB-H SERIES)

■RELIABILITY DATA

10 1: -						
1. Operating Tempe						
Specified Value	MB series	-40~+105°C				
	MB-H series	-40~+125°C				
Test Methods and Remarks	Including self-generated heat					
2. Storage Tempera	ture Range					
Cresified Value	MB series					
Specified Value	MB-H series					
Test Methods and Remarks	0 to 40°C for the product with taping.					
2 D-tl						
3. Rated current	lun .	T				
Specified Value	MB series	Within the specified tolerance				
	MB-H series					
4. Inductance						
Specified Value	MB series	Within the specified tolerance				
	MB-H series					
Test Methods and		1285A or equivalent)				
Remarks	Measuring frequency : 1MHz, 1V					
5. DC Resistance						
Specified Value	MB series	Within the specified tolerance				
•	MB-H series	· ·				
Test Methods and Remarks	Measuring equipment : DC ohmmeter (H	IOKI 3227 or equivalent)				
0.016						
6. Self resonance fr						
Specified Value	MB series	_				
	MB-H series					
7. Temperature cha						
Specified Value	MB series	Inductance change : Within ±15%				
	MB-H series					
Test Methods and	MB series : Measurement of inductance shall be taken at temperature range within $-40^{\circ}\text{C} \sim +105^{\circ}\text{C}$. With reference to inductance value at $+20^{\circ}\text{C}$, change rate shall be calculated.					
Remarks						

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8. Resistance to fle	xure of substrate				
	MB series				
Specified Value	MB-H series		No damage		
Test Methods and Remarks	The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2 mm. Test board size : 100 × 40 × 1.0 mm (1608:0.8mm) Test board material : Glass epoxy-resin Solder cream thickness : 0.1 mm				
9. Insulation resista	nce : between wires				
	MB series				
Specified Value	MB-H series		_		
	<u> </u>		I.		
10 Insulation resist	ance : between wire and core	9			
70. Insulation resist	MB series		DC25V 100kΩ min		
Specified Value	MB-H series		DC50V 100kΩ min		
	IVID-IT Series		DOGON LOOK IX LIIILI		
11. Withstanding vol	Itage : between wire and core				
Specified Value	MB series		_		
	MB-H series				
12. Adhesion of terr	minal electrode MB series				
Specified Value	MB-H series		No abnormality.		
Test Methods and Remarks	The test samples shall be s Applied force Duration Solder cream thickness		st board by the reflow. I) to X and Y directions.		
12 Posistanas ta vi	ihration				
13. Resistance to vi					
Specified Value	MB series		Inductance change : Within ±10% No significant abnormality in appearance.		
	MB-H series	11 17 21 1			
	The test samples shall be seen that the second of the seco				
	Frequency Range	10∼55Hz			
Test Methods and	Total Amplitude	1.5mm (May not	exceed acceleration 196m/s²)		
Remarks	Sweeping Method	10Hz to 55Hz to	o 10Hz for 1min.		
TO THE TOTAL OF TH	Time	X Y Z	For 2 hours on each X, Y, and Z axis.		
	Recovery : At least 2hrs of	recovery under t	he standard condition after the test, followed by the measurement within 48hrs.		
14. Solderability					
Specifical VII	MB series		At least 0006 of ourface of township latestands in account.		
Specified Value	MB-H series		At least 90% of surface of terminal electrode is covered by new solder.		
Test Methods and	Flux : Methanol solution co Solder Temperature	ntaining rosin 25%.	then immersed in molten solder as shown in below table.		
Remarks	Immersing speed	25mm/s	_		

5±0.5 sec. *Immersion depth : All sides of mounting terminal shall be immersed.

Time

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15. Resistance to se	15. Resistance to soldering heat				
Specified Value	MB series	Inductance change : Within ±10%			
Specified value	MB-H series	No significant abnormality in appearance.			
	The test sample shall be exposed to reflow oven at 230°C for 40 seconds, with peak temperature at $260 + 0/-5$ °C for 5 seconds, 3 times.				
Test Methods and	Test board material : Glass epoxy-resin				
Remarks	Test board thickness : 1.0mm				
	Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.				

16. Thermal shock									
Specified Value	MB series			Inductance cha	Inductance change : Within ±10%				
Specified Value	MB-H series			No significant a	bnorm	ality in app	pearance.		
	MB series:					MB-H se	eries:		
	The test	samples shall be soldered	to the tes	st board by the re	eflow.	The test	samples shall be soldered	to the test board by the reflow.	
	The test samples shall be placed at specified temperature				e for	The test samples shall be placed at specified temperature for			
	specified time by step 1 to step 4 as shown in below tab				le in	specified time by step 1 to step 4 as shown in below table in			
	sequence. The temperature cycle shall be repeated 100 c			peated 100 cycle	S.	sequence. The temperature cycle shall be repeated 100 cycles.			
To at Mother de and	Conditions of 1 cycle						Conditions of 1 cycle		
Test Methods and Remarks	Step	Temperature (°C)	Dur	ration (min)		Step	Temperature (°C)	Duration (min)	
Remarks	1	-40 ± 3		30±3		1	-40 ± 3	30±3	
	2	Room temperature	,	Within 3		2	Room temperature	Within 3	
	3	+85±2		30±3		3	+125±2	30±3	
	4	Room temperature	,	Within 3		4	Room temperature	Within 3	
	Recovery : At least 2hrs of recovery under the standard cond					Recover	y : At least 2hrs of recove	ry under the standard condition	

after the test, followed by the measurement within 48hrs.

17. Damp heat						
C:E1 V-l	MB series		Inductance change : V	Vithin ±10%		
Specified Value	MB-H series		No significant abnorm	No significant abnormality in appearance.		
	· ·	nall be soldered to the tes	•	MB-H series: The test samples shall be soldered to the test board by the reflo The test samples shall be placed in thermostatic oven set		
Test Methods and		re and humidity as shown		·		
Remarks	Temperature	60±2°C		Temperature	85±2°C	
	Humidity	90∼95%RH		Humidity	85%RH	
	Time	1000+24/-0 hour		Time	1000+24/-0 hour	
	Recovery: At least 2hrs of recovery under the			Recovery : At least	t 2hrs of recovery under th	e standard condition
	after the test, followed by the measurement within 48hrs.			after the test, follo	wed by the measurement w	rithin 48hrs.

after the test, followed by the measurement within 48hrs.

18. Loading under d	amn heat					
To. Loading direct d	MB series		Inductance change : V	Vithin + 10%		
Specified Value	lue MB-H series		No significant abnormality in appearance.			
	MB series:			MB-H series:		
	The test samples shall be soldered to the test board by the reflow			The test samples shall be soldered to the test board by the reflow.		
	The test samples shall be placed in thermostatic oven s			The test samples shall be placed in thermostatic oven set at		
	specified temperatur	e and humidity and appl	ied the rated current	specified temperature and humidity and applied the rated curr		
Test Methods and	continuously as show	vn in below table.		continuously as show	wn in below table.	_
Remarks	Temperature	60±2°C		Temperature	85±2°C	
	Humidity	90∼95%RH		Humidity	85%RH	
	Applied current	Rated current		Applied current	Rated current	
	Time	1000+24/-0 hour		Time	1000+24/-0 hour	
	Recovery: At least 2hrs of recovery under the standard condition			Recovery: At least 2hrs of recovery under the standard condition		
	after the test, follow	ed by the measurement v	within 48hrs.	after the test, follow	ed by the measurement w	ithin 48hrs.

19. Low temperatur	e life test			
MB series			Inductance change : Within ±10%	
Specified Value	MB-H series		No significant abnormality in appearance.	
Test Methods and	The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as s in below table.			
Remarks	Temperature	-40±2°C		
	Time	1000+24/-0 hour		
Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the measurement with				

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20. High temperatur	e life test		
Specified Value	MB series		Inductance change : Within ±10%
Specified Value	MB-H series		No significant abnormality in appearance.
Test Methods and	The test samples shal in below table.		t board by the reflow. After that, the test samples shall be placed at test conditions as shown
Remarks	Temperature	85±2°C	
	Time	1000+24/-0 hour	
	Recovery : At least 2	nrs of recovery under th	ne standard condition after the test, followed by the measurement within 48hrs.
21. Loading at high	temperature life test		
Specified Value	MB series		
Specified Value	MB-H series		
22. Standard condit	ion		
Specified Value	cified Value MB-H series		Standard test condition: Unless otherwise specified, temperature is $20\pm15^{\circ}$ C and $65\pm20\%$ of relative humidity. When there is any question concerning measurement result: In order to provide correlation
Specified Value			data, the test shall be condition of $20\pm2^{\circ}\text{C}$ of temperature, $65\pm5\%$ relative humidity. Inductance is in accordance with our measured value.

METAL WIRE-WOUND CHIP POWER INDUCTORS (MCOIL™ MB SERIES ∕ MCOIL™ MB-H SERIES)

PRECAUTIONS

1. Circuit Design

Precautions

◆Operating environment

1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

2. PCB Design

Precautions

- **♦**Land pattern design
- 1. Please refer to a recommended land pattern.

Technical considerations

◆Land pattern design Surface Mounting

- · Mounting and soldering conditions should be checked beforehand.
- · Applicable soldering process to this products is reflow soldering only.

3. Considerations for automatic placement

Precautions

- Adjustment of mounting machine
- 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.
- 2. Mounting and soldering conditions should be checked beforehand.

Technical considerations

- ◆Adjustment of mounting machine
 - 1. When installing products, care should be taken not to apply distortion stress as it may deform the products

4. Soldering

◆Reflow soldering

- 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified.
- 2. The product shall be used reflow soldering only.

Precautions

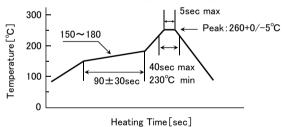
- 3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering.
- ◆Lead free soldering
 - 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently.

◆Reflow soldering

1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

Recommended reflow condition (Pb free solder)

Technical considerations



5. Cleaning

Precautions

- **♦**Cleaning conditions
 - 1. Washing by supersonic waves shall be avoided.

Technical considerations

◆Cleaning conditions

1. If washed by supersonic waves, the products might be broken.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

6. Handling	
Precautions	 ♦ Handling 1. Keep the product away from all magnets and magnetic objects. ♦ Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ♦ Mechanical considerations 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ♦ Pick-up pressure 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ♦ Packing 1. Please avoid accumulation of a packing box as much as possible.
Technical considerations	 ✦ Handling 1. There is a case that a characteristic varies with magnetic influence. ✦ Breakaway PC boards (splitting along perforations) 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ✦ Mechanical considerations 1. There is a case to be damaged by a mechanical shock. 2. There is a case to be broken by the handling in transportation. ✦ Pick-up pressure 1. Damage and a characteristic can vary with an excessive shock or stress. ✦ Packing 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.

Precautions	 ◆Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. Recommended conditions Ambient temperature: 0~40°C Humidity: Below 70% RH The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used within 6 months from the time of delivery.
	In case of storage over 6 months, solderability shall be checked before actual usage. Storage
Technical considerations	Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.

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